

# AN8480NSB

## 3-phase full-wave motor driver IC

### ■ Overview

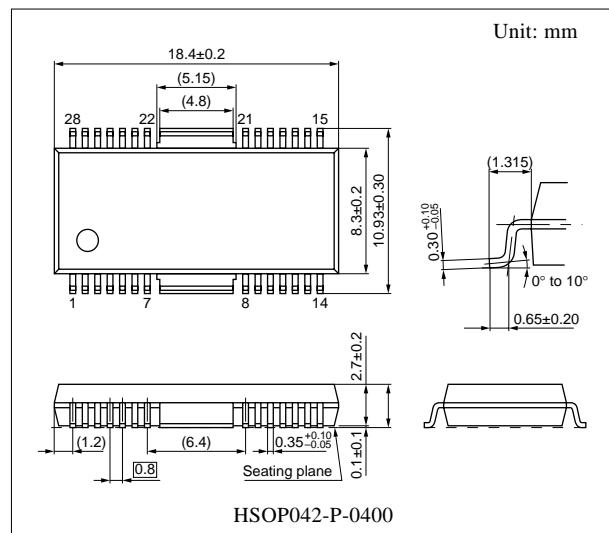
The AN8480NSB is a 3-phase full-wave motor driver IC with a reverse rotation brake/short brake changeover function, incorporating a thermal protection circuit with its protection monitor pin.

### ■ Features

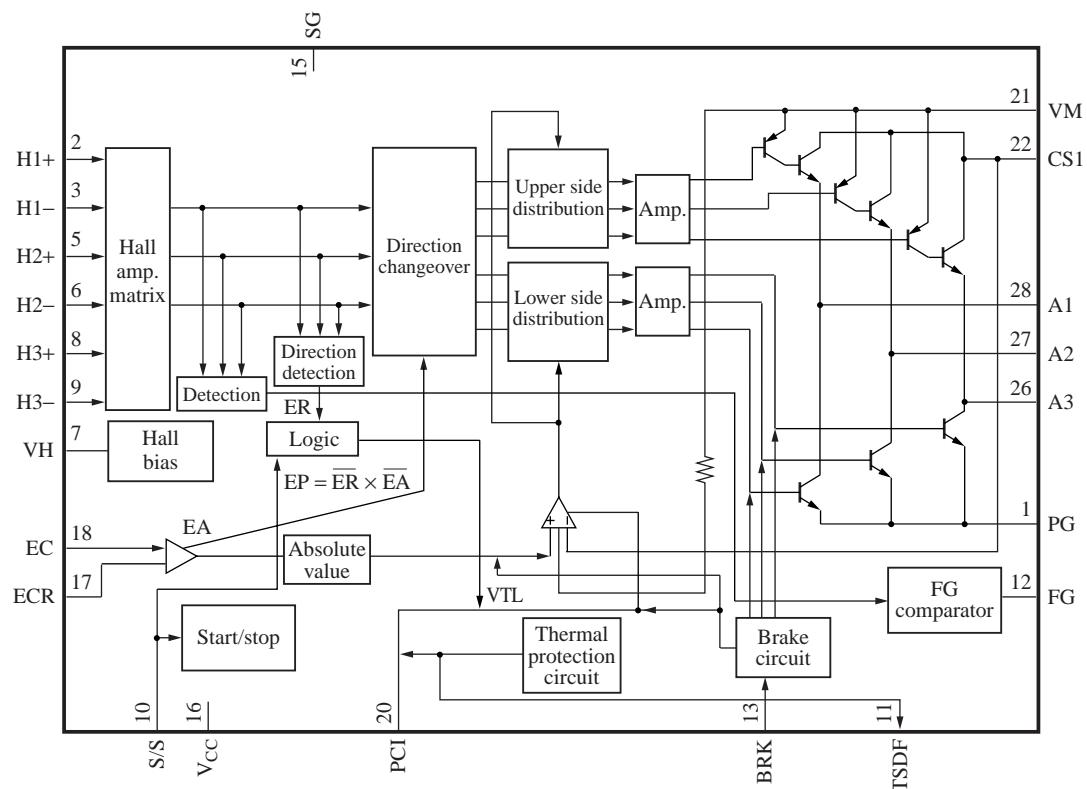
- 3-phase full-wave and snubberless
- FG output
- Current limit
- Reverse rotation prevention
- Thermal protection circuit built-in (with thermal protection monitor pin)

### ■ Applications

- Various types of optical disk drive



### ■ Block Diagram



## ■ Pin Descriptions

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	PG	Power GND pin	15	SG	Signal GND pin
2	H1+	Hall element-1 positive input pin	16	V <sub>CC</sub>	Supply voltage pin
3	H1-	Hall element-1 negative input pin	17	ECR	Torque command reference input pin
4	N.C.	N.C.	18	EC	Torque command input pin
5	H2+	Hall element-2 positive input pin	19	N.C.	N.C.
6	H2-	Hall element-2 negative input pin	20	PCI	Current feedback phase compensation pin
7	VH	Hall bias pin	21	VM	Motor supply voltage pin
8	H3+	Hall element-3 positive input pin	22	CS	Current det. pin 1
9	H3-	Hall element-3 negative input pin	23	N.C.	N.C.
10	SS	Start/stop changeover pin	24	N.C.	N.C.
11	TFLG	Thermal protection monitor pin	25	N.C.	N.C.
12	FG	FG signal output pin	26	A3	Drive output 3
13	BRK	Brake mode setting pin	27	A2	Drive output 2
14	N.C.	N.C.	28	A1	Drive output 1

## ■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	7.0	V
	V <sub>M</sub>	14.4	
Control signal input voltage <sup>*4</sup>	V <sub>(n)</sub>	0 to V <sub>CC</sub>	V
Supply current	I <sub>CC</sub>	30	mA
Output current <sup>*3</sup>	I <sub>O(n)</sub>	±1 200	mA
Hall bias current	I <sub>HB</sub>	50	mA
Power dissipation <sup>*2</sup>	P <sub>D</sub>	667	mW
Operating ambient temperature <sup>*1</sup>	T <sub>opr</sub>	-20 to +70	°C
Storage temperature <sup>*1</sup>	T <sub>stg</sub>	-55 to +150	°C

Note) Do not apply external currents or voltages to any pins not specifically mentioned.

For circuit currents, '+' denotes current flowing into the IC, and '-' denotes current flowing out of the IC.

\*1: Except for the operating ambient temperature and storage temperature, all ratings are for T<sub>a</sub> = 25°C.

\*2: For 70°C and IC alone.

\*3: n = 1, 22, 26, 27, 28

\*4: n = 2, 3, 5, 6, 8, 9, 10, 13, 17, 18

## ■ Recommended Operating Range

Parameter	Symbol	Range	Unit
Supply voltage	V <sub>CC</sub>	4.25 to 5.5	V
	V <sub>M</sub>	4.5 to 14	

■ Electrical Characteristics at  $T_a = 25^\circ\text{C}$ 

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>Overall</b>						
Circuit current 1	$I_{CC1}$	$V_{CC} = 5 \text{ V}$ in power save mode	—	0	0.1	mA
Circuit current 2	$I_{CC2}$	$V_{CC} = 5 \text{ V}$ , $I_O = 0 \text{ mA}$	1	8	16	mA
<b>Start/stop</b>						
Start voltage	$V_{START}$	Voltage with which a circuit operates at $V_{CC} = 5 \text{ V}$ and $L \rightarrow H$	2.7	—	—	V
Stop voltage	$V_{STOP}$	Voltage with which a circuit becomes off at $V_{CC} = 5 \text{ V}$ and $H \rightarrow L$	—	—	0.7	V
Medium voltage	$V_{MED}$	Voltage with which $V_{PC1}$ becomes low at $V_{CC} = 5 \text{ V}$ and $EC = 0 \text{ V}$	1.55	—	1.75	V
<b>Hall bias</b>						
Hall bias voltage	$V_{HB}$	$V_{CC} = 5 \text{ V}$ , $I_{HB} = 20 \text{ mA}$	0.7	1.2	1.6	V
<b>Hall amplifier</b>						
Input bias current	$I_{BH}$	$V_{CC} = 5 \text{ V}$	—	1	5	$\mu\text{A}$
In-phase input voltage range	$V_{HBR}$	$V_{CC} = 5 \text{ V}$	1.5	—	4.0	V
Minimum input level	$V_{INH}$	$V_{CC} = 5 \text{ V}$	60	—	—	$\text{mV[p-p]}$
<b>Torque command</b>						
In-phase input voltage range	$EC$	$V_{CC} = 5 \text{ V}$	0.5	—	3.9	V
Offset voltage	$EC_{OF}$	$V_{CC} = 5 \text{ V}$	-100	0	100	$\text{mV}$
Dead zone	$EC_{DZ}$	$V_{CC} = 5 \text{ V}$	25	75	125	$\text{mV}$
Input current	$EC_{IN}$	$V_{CC} = 5 \text{ V}$ , $EC = ECR = 1.65 \text{ V}$	-5	-1	—	$\mu\text{A}$
Input/output gain	$A_{CS}$	$V_{CC} = 5 \text{ V}$ , $R_{CS} = 0.5 \Omega$	0.75	1.0	1.25	A/V
<b>Output</b>						
High-level output saturation voltage	$V_{OH}$	$V_{CC} = 5 \text{ V}$ , $I_O = -300 \text{ mA}$	—	0.9	1.6	V
Low-level output saturation voltage	$V_{OL}$	$V_{CC} = 5 \text{ V}$ , $I_O = 300 \text{ mA}$	—	0.2	0.6	V
Torque limit current	$I_{TL}$	$V_{CC} = 5 \text{ V}$ , $R_{CS} = 0.5 \Omega$	400	500	600	mA
<b>FG</b>						
FG output high-level	$FG_H$	$V_{CC} = 5 \text{ V}$ , $I_{FG} = -0.01 \text{ mA}$	3.0	—	$V_{CC}$	V
FG output low-level	$FG_L$	$V_{CC} = 5 \text{ V}$ , $I_{FG} = 0.01 \text{ mA}$	—	—	0.5	V
In-phase input voltage range	$V_{FGR}$	$V_{CC} = 5 \text{ V}$ , Input D-range at H2+, H2-	1.5	—	3.0	V
FG hysteresis width	$H_{FG}$	$V_{CC} = 5 \text{ V}$	1	10	20	$\text{mV}$
<b>Brake circuit</b>						
Short brake model level	$V_{SBR}$	$V_{CC} = 5 \text{ V}$	—	—	1.0	V
Reverse rotation brake mode level	$V_{RBR}$	$V_{CC} = 5 \text{ V}$	3.5	—	—	V
Short brake start level	$V_{SBRL}$	$V_{CC} = 5 \text{ V}$ , $ECR = 1.65 \text{ V}$	1.65	1.74	—	V
Short brake current	$I_{SBR}$	$V_{CC} = 5 \text{ V}$	12	35	—	mA

## ■ Electrical Characteristics at $T_a = 25^\circ\text{C}$ (continued)

- Design reference data

Note) The characteristics listed below are theoretical values based on the IC design and are not guaranteed.

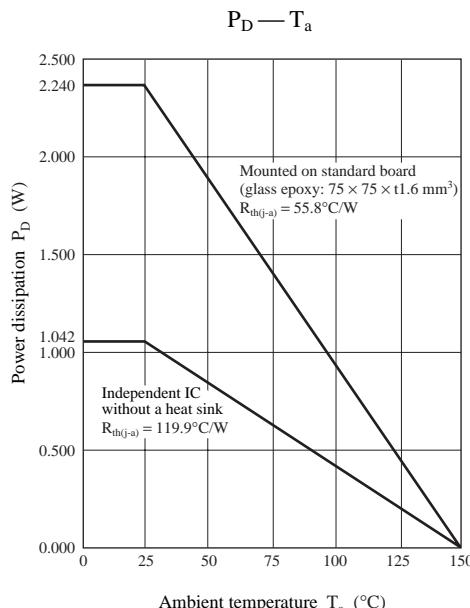
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>Thermal protection</b>						
Thermal protection operating temperature	$T_{SDON}$	$V_{CC} = 5 \text{ V}, \Delta EC = 100 \text{ mV}$	—	160	—	°C
Thermal protection hysteresis width	$\Delta T_{SD}$	$V_{CC} = 5 \text{ V}, \Delta EC = 100 \text{ mV}$	—	45	—	°C
<b>Thermal protection flag</b>						
Level at thermal protection = on	$V_{TSDON}$	$V_{CC} = 5 \text{ V}$	—	—	0.5	V
Level at thermal protection = off	$V_{TSDOFF}$	$V_{CC} = 5 \text{ V}$	3.0	—	—	V

## ■ Usage Notes

Prevent this IC from being line-to-ground fault. (To be concrete, do not short-circuit any of A1 (pin 28), A2 (pin 27) and A3 (pin 26) with VM pin (pin 21).)

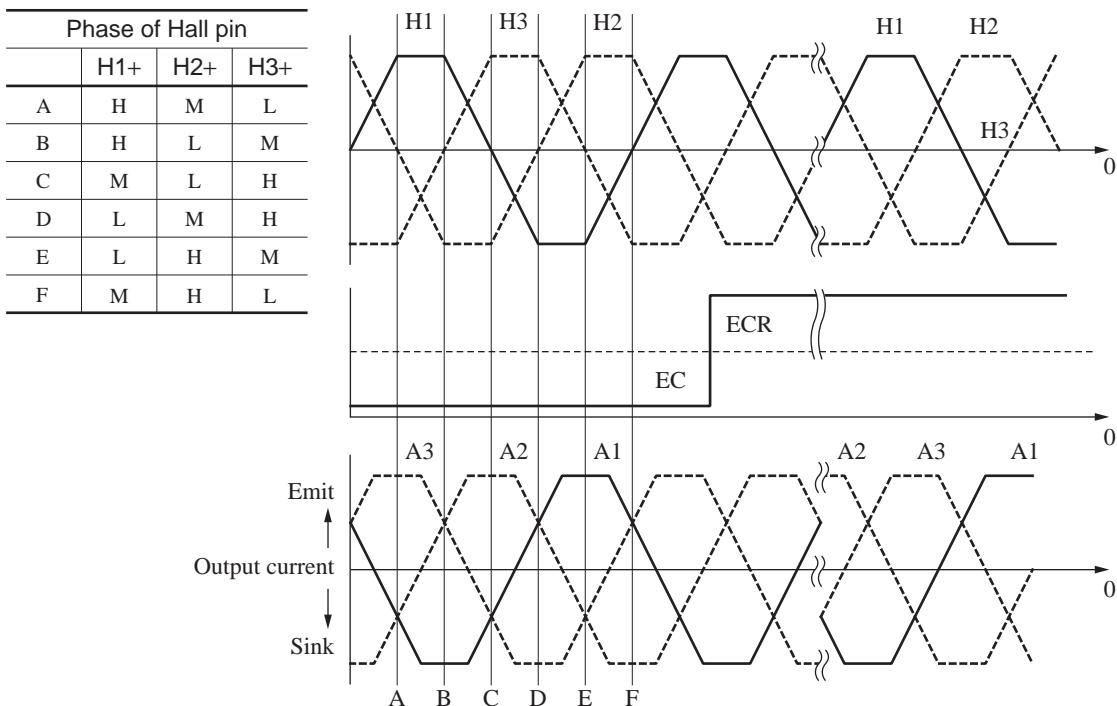
## ■ Application Notes

- $P_D - T_a$  curves of HSOP042-P-0400



## ■ Application Notes (continued)

- Phase conditions between Hall input and output current



- Power consumption calculation method

You can find a rough value of electric power to be consumed in the IC in the following method and the use of EXCEL (computer soft ware) will enable you to put it on a graph.

Calculating formula:

1. Let an induced voltage generated in each phase as below:

(Reference to a motor center point)

$$E_{A1} = E_O \times \sin(X) \cdots (1)$$

$$E_{A2} = E_O \times \sin(X+120) \cdots (2)$$

$$E_{A3} = E_O \times \sin(X+240) \cdots (3)$$

X: Phase angle

2. Let a current flowing in each phase as below:

$$I_{A1} = I_O \times \sin(X) \cdots (4)$$

$$I_{A2} = I_O \times \sin(X+120) \cdots (5)$$

$$I_{A3} = I_O \times \sin(X+240) \cdots (6)$$

3. The voltages generated by a wire-wound resistance of a motor are:

$$V_{R1} = I_{A1} \times R \cdots (7)$$

$$V_{R2} = I_{A2} \times R \cdots (8)$$

$$V_{R3} = I_{A3} \times R \cdots (9)$$

4. In each phase, add the voltage generated by an induced voltage and that by a wire-wound resistance.

$$V_{A1}' = (1) + (4)$$

$$V_{A2}' = (2) + (5)$$

$$V_{A3}' = (3) + (6)$$

5. As the lowest voltage in each phase angle must be 0 V, you can get the voltage to be generated in each phase by means of subtracting the lowest voltage from the voltage of the remaining two phases.

$$V_{A1} = V_{A1}' - \text{MIN}(V_{A1}', V_{A2}', V_{A3}') \cdots (10)$$

$$V_{A2} = V_{A2}' - \text{MIN}(V_{A1}', V_{A2}', V_{A3}') \cdots (11)$$

$$V_{A3} = V_{A3}' - \text{MIN}(V_{A1}', V_{A2}', V_{A3}') \cdots (12)$$

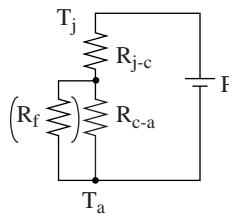
6. Subtract the supply voltage from each phase's voltage found in item 5 and then multiply it by each phase's current, so that you can get the power consumption.

$$P = \sum_{n=1}^3 (12 - V_{An}) \times I_{An}$$

## ■ Application Notes (continued)

- Theory of thermal resistance

A chip temperature or the fin temperature can be understood in the same way as Ohm's Law.



$T_j$  : Chip temperature

$T_a$  : Ambient temperature

$P$  : Electric power generated by IC

$R_{j-c}$  : Thermal resistance between a chip and a package

$R_{c-a}$  : Thermal resistance between a package and a surface of a heat sink or free air

$R_f$  : Thermal resistance between a package and surface of a heat sink

$$T_j = T_a + P \times (R_{j-c} + R_{c-a} // R_f)$$

Make sure that  $T_j$  does not exceed 150°C.

If it exceeds 150°C, you can suppress the rise of a chip temperature by adding a heat sink which is equivalent to  $R_f$  in the above figure.

$$T_j = T_a + P \times (R_{j-c} + R_{c-a} // R_f)$$

A package surface and the fin are available for a temperature measurement. But the fin part is recommendable for measurement because a package surface measurement does not always promise you a consistent measuring result.

## ■ Application Circuit Example

